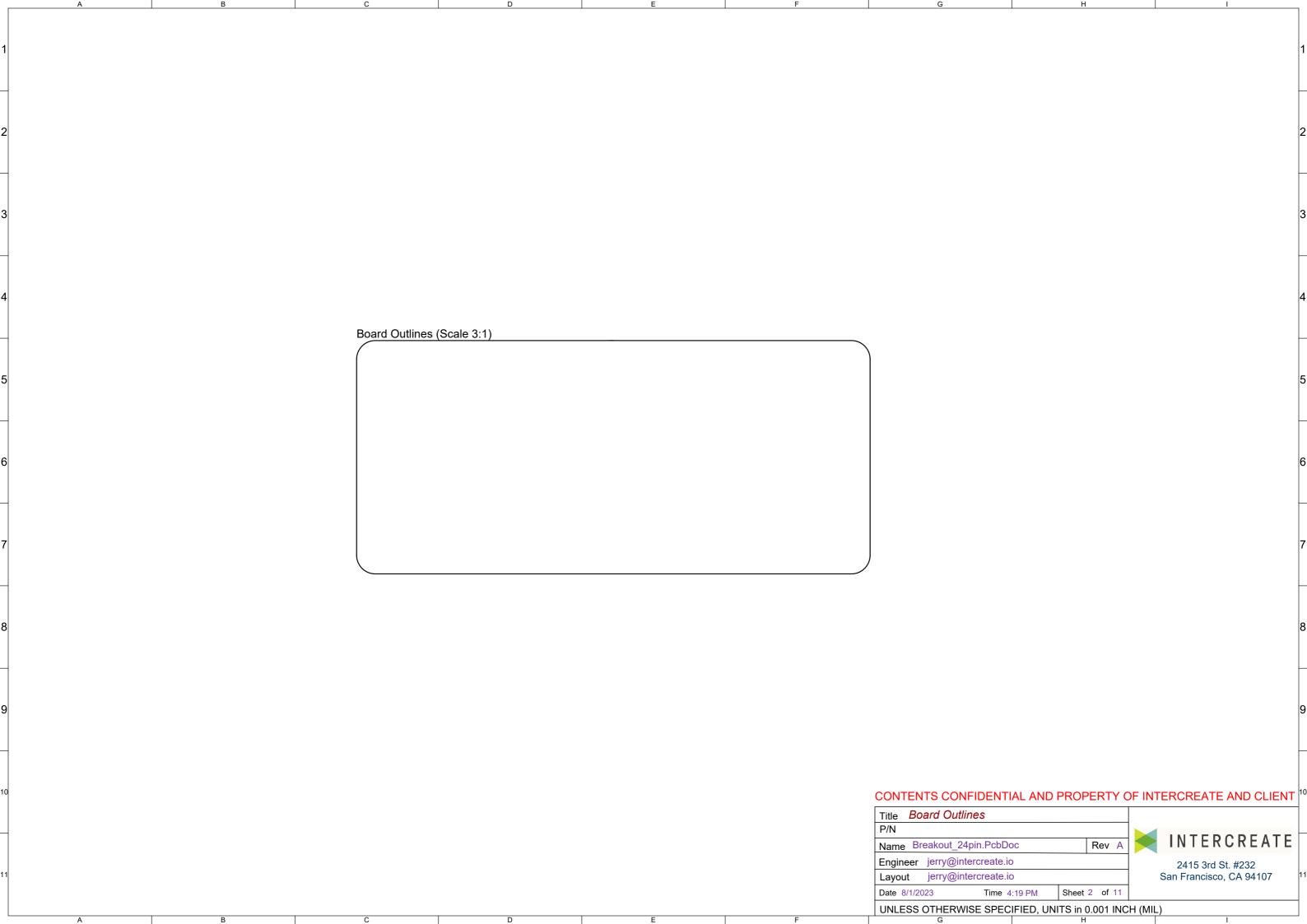
NOTES (Unless otherwise specified) PCB MATERIAL FR4 or similar SOLDER ENIG per IPC-4552 WASHABLE YES COPPER WEIGHT FOR OUTER LAYERS 10Z ENIG per IPC-4552 **PCB PLATING** VIA SIZE See Drill Table VIA IN PAD NO **VIA FILL** NO **VIA TENTING BOTH SIDES** SOLDER MASK COLOR **GRAY** SILK SCREEN COLOR WHITE ACCEPTANCE IPC-A-600 Class II **PCB FINISH** IPC-4552 Layer Stack Legend Material Layer Thickness Dielectric Material Type Gerber Dk GTO Top Overlay Legend Surface Material Top Solder 0.010mm Solder Resist Solder Mask GTS 3.5 Top Layer 0.036mm Signal GTL Copper 1.500mm FR-4 Dielectric 4.8 Copper **Bottom Layer** 0.036mm Signal GBL Surface Material Bottom Solder 0.010mm Solder Resist Solder Mask GBS 3.5 GBO **Bottom Overlay** Legend Total thickness: 1.591mm CONTENTS CONFIDENTIAL AND PROPERTY OF INTERCREATE AND CLIENT 10 Title FABRICATION DRAWING P/N INTERCREATE Name Breakout\_24pin.PcbDoc Rev A Engineer jerry@intercreate.io 2415 3rd St. #232 San Francisco, CA 94107 jerry@intercreate.io Layout

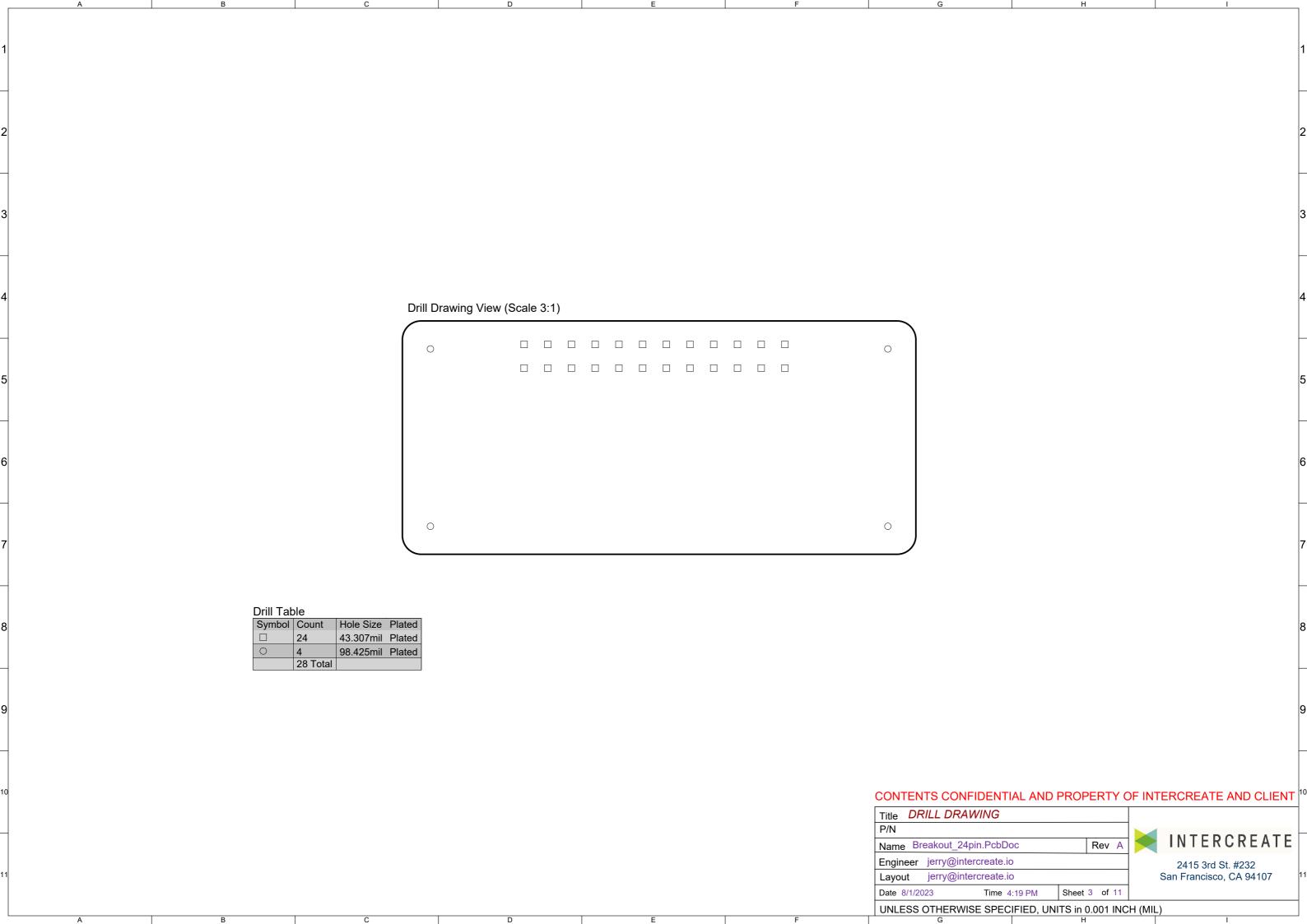
Date 8/1/2023

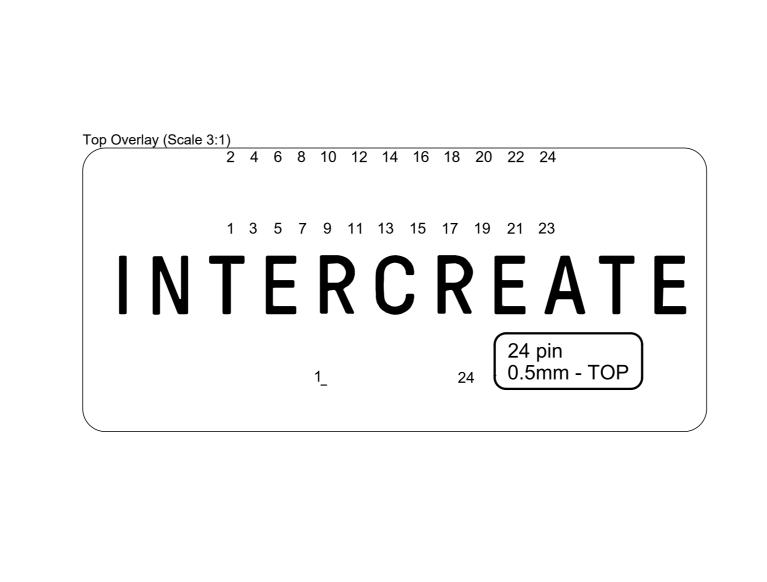
Time 4:19 PM

UNLESS OTHERWISE SPECIFIED, UNITS in 0.001 INCH (MIL)

Sheet 1 of 11







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Sheet 4 of 11

Rev A

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Title

P/N

Date 8/1/2023

TOP LAYER SILKSCREEN

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Name Breakout\_24pin.PcbDoc

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